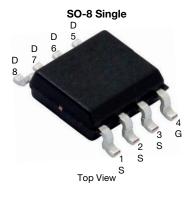


Vishay Siliconix

N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω) MAX.	I _D (A) ^a	Q _g (TYP.)			
30	0.0140 at V _{GS} = 10 V	14	7.3 nC			
30	0.0175 at V _{GS} = 4.5 V	12.5	1.5110			



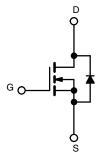
FEATURES

- TrenchFET® power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- DC/DC conversion
 - Notebook system power



N-Channel MOSFET

Ordering Information:

Si4134DY-T1-E3 (lead (Pb)-free) Si4134DY-T1-GE3 (lead (Pb)-free and halogen-free)

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage Gate-Source Voltage		V _{DS}	30 ± 20	.,,
		V _{GS}		V
	T _C = 25 °C		14	
Continuous Dusis Comment /T 150 °C)	T _C = 70 °C		11.2	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	9.9 b, c	
	T _A = 70 °C		7.9 ^{b, c}	
Pulsed Drain Current (t = 300 μs)		I _{DM}	50	A
Continuous Courses Duein Die de Coursest	T _C = 25 °C		4.1	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2 b, c	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	15	
Avalanche Energy		E _{AS}	11.25	mJ
	T _C = 25 °C		5	
Martin or Broad Birelandia	T _C = 70 °C		3.2	14/
Maximum Power Dissipation	T _A = 25 °C	P _D	2.5 ^{b, c}	W
	T _A = 70 °C		1.6 ^{b, c}	
Operating Junction and Storage Temperatur	T _J , T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum Junction-to-Ambient b, d	t ≤ 10 s	R_{thJA}	38	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	20	25	C/VV		

Notes

- a. Based on $T_C = 25$ °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 85 °C/W.



Vishay Siliconix

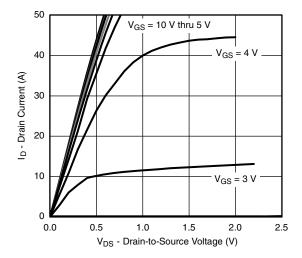
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	V	
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J		-	33	-	m\//°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I _D = 250 μA	-	-5	-	mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \ \mu A$	1.2	1.8	2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zana Onto Welliam Busin On and		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	_	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C	-	-	10	μA	
On-State Drain Current a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20	-	-	Α	
D : 0	, ,	V _{GS} = 10 V, I _D = 10 A	-	- 0.0115 0.0140 - 0.0145 0.0175		-	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$	-			Ω	
Forward Transconductance a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A	-	24	-	S	
Dynamic ^b		-		L			
Input Capacitance	C _{iss}		-	846	-	pF	
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	-	187	-		
Reverse Transfer Capacitance	C _{rss}		-	72	-		
		V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A	-	15.4	23	nC	
Total Gate Charge			-	7.3	11		
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	2.3	-		
Gate-Drain Charge	Q _{ad}		-	2.2	-		
Gate Resistance	R_g	f = 1 MHz	0.2	0.8	1.6	Ω	
Turn-On Delay Time	t _{d(on)}		-	15	30		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{I} = 1.5 \Omega$	-	12	24		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	13	26		
Fall Time	t _f	1	-	10	20		
Turn-On Delay Time	t _{d(on)}		-	9	18	ns -	
Rise Time	t _r	$V_{DD} = 15 \text{ V, R}_{I} = 1.5 \Omega$	-	9	18		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	14	28		
Fall Time	t _f	1	-	8	16		
Drain-Source Body Diode Characterist	ics			L			
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C	-	-	4.2		
Pulse Diode Forward Current ^a	I _{SM}	-	-	-	50	Α	
Body Diode Voltage	V _{SD}	I _S = 3 A	-	0.78	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}	_	-	17	34	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	1 <u>.</u>	-	9.5	19	nC	
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$	-	10	-	ns	

Notes

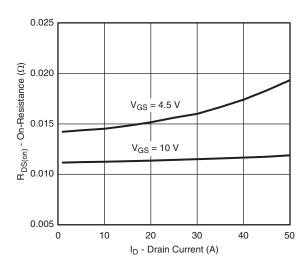
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

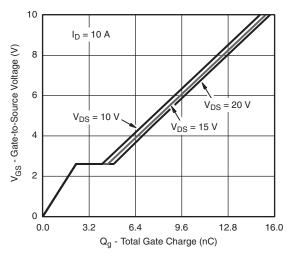




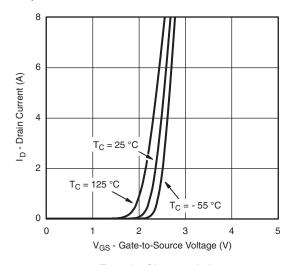
Output Characteristics



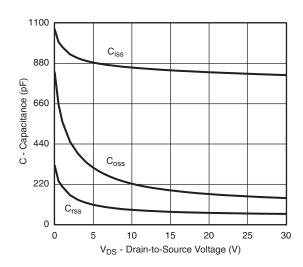
On-Resistance vs. Drain Current and Gate Voltage



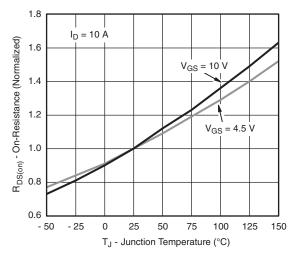
Gate Charge



Transfer Characteristics

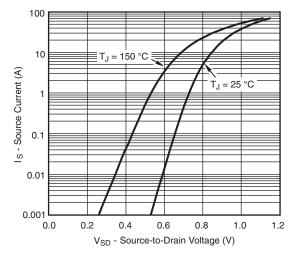


Capacitance

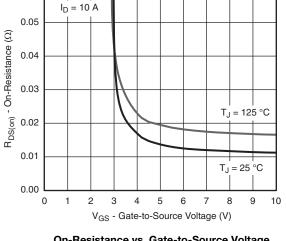


On-Resistance vs. Junction Temperature



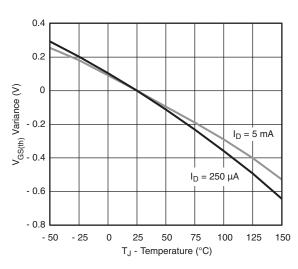


Source-Drain Diode Forward Voltage

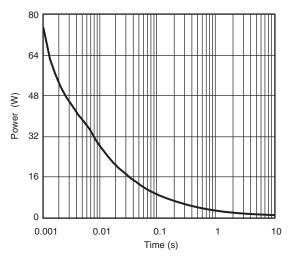


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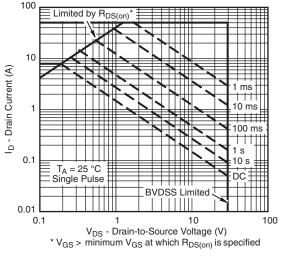
On-Resistance vs. Gate-to-Source Voltage



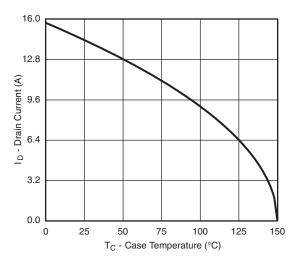
Threshold Voltage



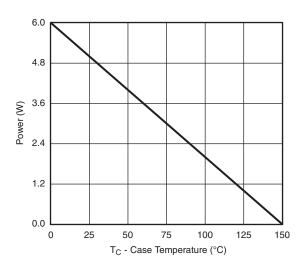
Single Pulse Power, Junction-to-Ambient

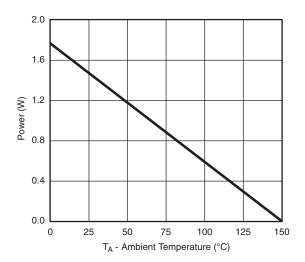






Current Derating a





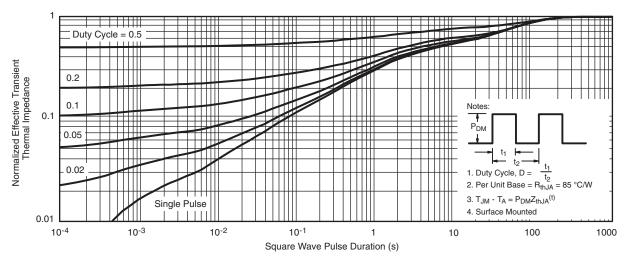
Power, Junction-to-Foot

Power Derating, Junction-to-Ambient

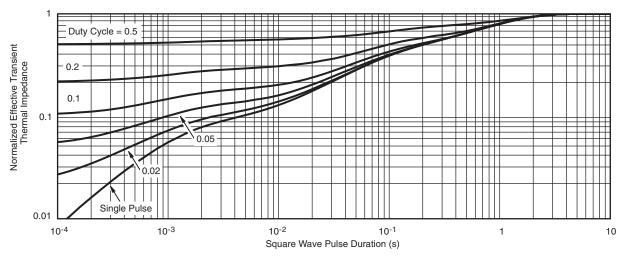
Note

a. The power dissipation P_D is based on T_J (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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